



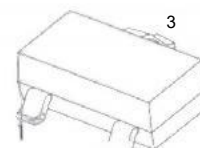
AO3404A

N-Channel Enhancement MOSFET

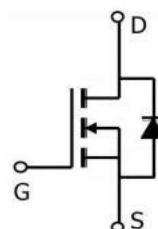
SOT-23

Features

- $V_{DS}(V)=30V$
- $I_b=5.8A$ $V_{GS}=(10V)$
- $R_{DS(ON)}<25m\Omega(V_{GS}=10V)$
- $R_{DS(ON)}<36m\Omega(V_{GS}=4.5V)$



1.GATE
2.SOURCE
3.DRAIN



Absolute Maximum Ratings $T_a=25^{\circ}C$

Parameter		Symbol	Rating	Unit
Drain-Source Voltage		V_{DS}	30	V
Gate-Source Voltage		V_{GS}	± 20	
Continuous Drain Current	$T_a=25^{\circ}C$	I_D	5.8	A
	$T_a=100^{\circ}C$		4.9	
Pulsed Drain Current		I_{DM}	20	
Power Dissipation	$T_a=25^{\circ}C$	PD	1.4	W
	$T_a=70^{\circ}C$		1	
Thermal Resistance. Junction-to-Ambient	$t \leq 5sec$	R_{thJA}	90	$^{\circ}CW$
	Steady State		125	
Thermal Resistance. Junction-to-Lead		R_{thJL}	60	
Junction Temperature		T_J	150	$^{\circ}C$
Storage Temperature Range		T_{stg}	-55 to 150	

Electrical Characteristics Ta=25°C

Parameter	Symbol	Testconditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	VDss	ID=250 μ A, VGs=0V	30			V
Zero Gate Voltage Drain Current	IDSs	VDs=24V, VGs=0V			1	μ A
		VDs=24V, VGs=0V, TJ=55°C			5	
Gate-Body leakage current	IGss	VDs=0V, VGs= $\pm$ 20V			100	nA
Gate Threshold Voltage	VGS(th)	VDs=VGs ID=250 μ A	1	1.9	3	V
On state drain current	ID(ON)	VGs=4.5V, VDs=5V	20			A
Static Drain-Source On-Resistance	RDS(ON)	VGs=10V, ID=5.8A			25	m Ω
		VGs=4.5VID=5.0A			36	m Ω
Forward Transconductance	gFS	VDs=5V, ID=5.8A	10			S
Diode Forward Voltage	VSD	Is=1A		0.76	1	V
Maximum Body-Diode Continuous Current	Is				2.5	A
Reverse Transfer Capacitance	Ciss	VGs=0V, VDs=15V, f=1MHz		680	820	pF
Gate resistance	Coss			102		pF
Input Capacitance	Crss			77		pF
Output Capacitance	Rg	VGs=0V, VDs=0V, f=1MHz		3	3.6	2
Total Gate Charge (10V)	Qg	VGs=10V, VDs=15V, ID=5.8A		13.88	17	nC
Total Gate Charge (4.5V)	Qg			6.78	8.1	nC
Gate Source Charge	Qgs			1.8		nC
Gate Drain Charge	Qgd			3.12		nC
Turn-On Rise Time	tD(on)	VGs=10V, VDs=15V, RL=2.7 Ω , RGEN=32		4.6	6.5	ns
Turn-Off DelayTime	tr			3.8	5.7	ns
Turn-Off Fall Time	tD(off)			20.9	30	ns
Turn-On DeayTime	tf			5	7.5	ns
Body Diode Reverse Recovery Time	trr	IF=5.8A, di/dt=100A/ μ s		16.1	21	ns
Body Diode Reverse Recovery Charge	Qr	IF=5.8A, di/dt=100A/ μ s		7.4	10	nC

Typical Characteristics

AO3404A

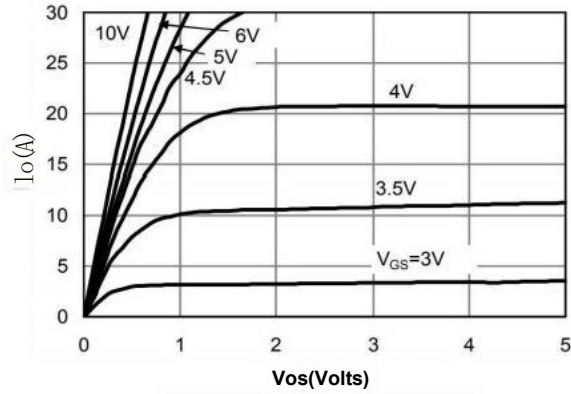


Fig 1: On-Region Characteristics

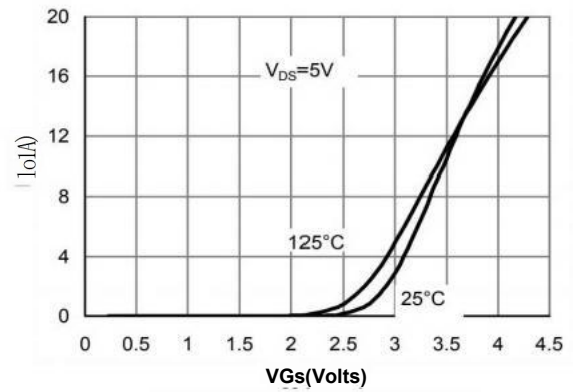


Figure 2: Transfer Characteristics

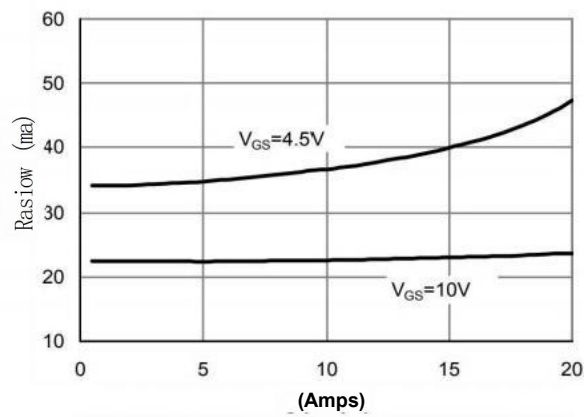


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

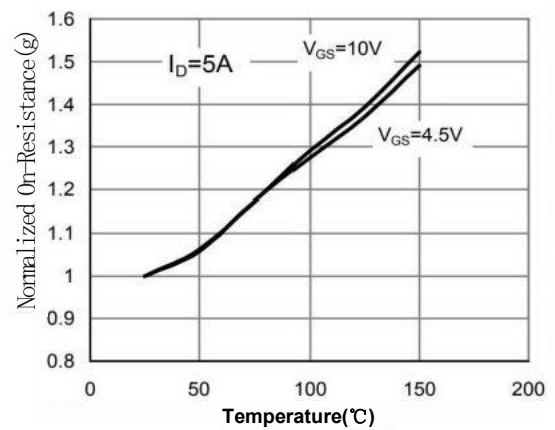


Figure 4: On-Resistance vs. Junction Temperature

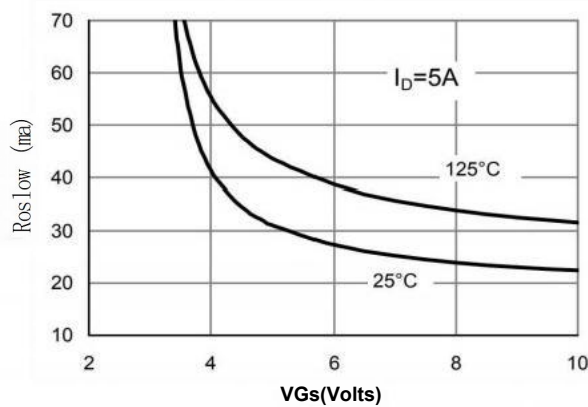


Figure 5: On-Resistance vs. Gate-Source Voltage

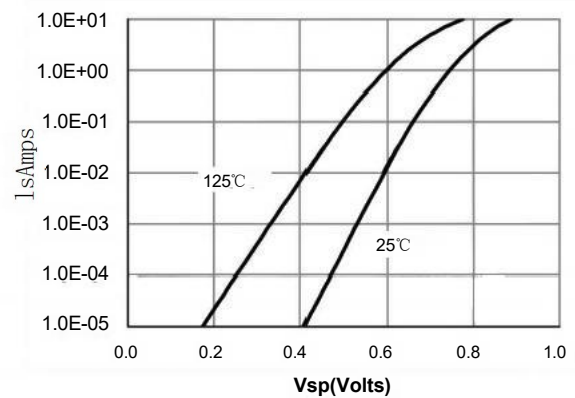


Figure 6: Body diode characteristics

Typical Characterisitics

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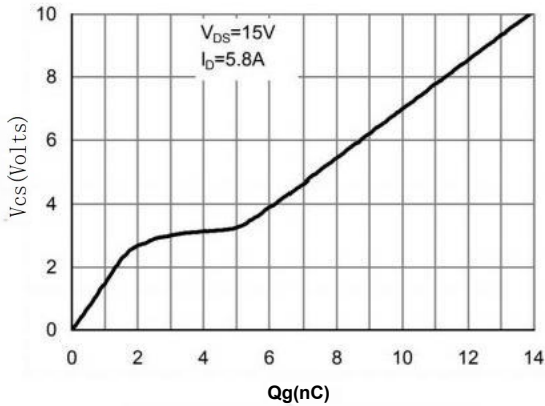


Figure 7:Gate-Charge characteristics

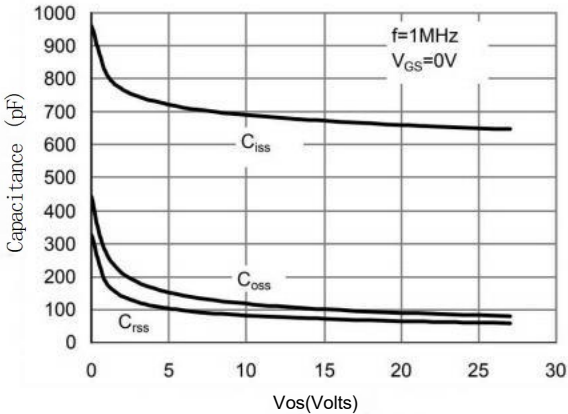


Figure 8:Capacitance Characteristics

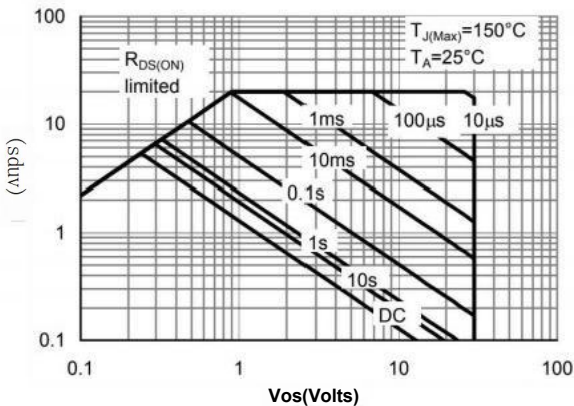


Figure 9:Maximum Forward Biased Safe Operating Area(Note E)

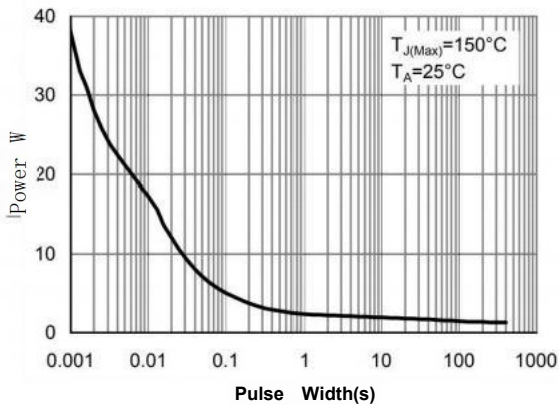


Figure 10:Single Pulse Power Rating Junction-to-Ambient(Note E)

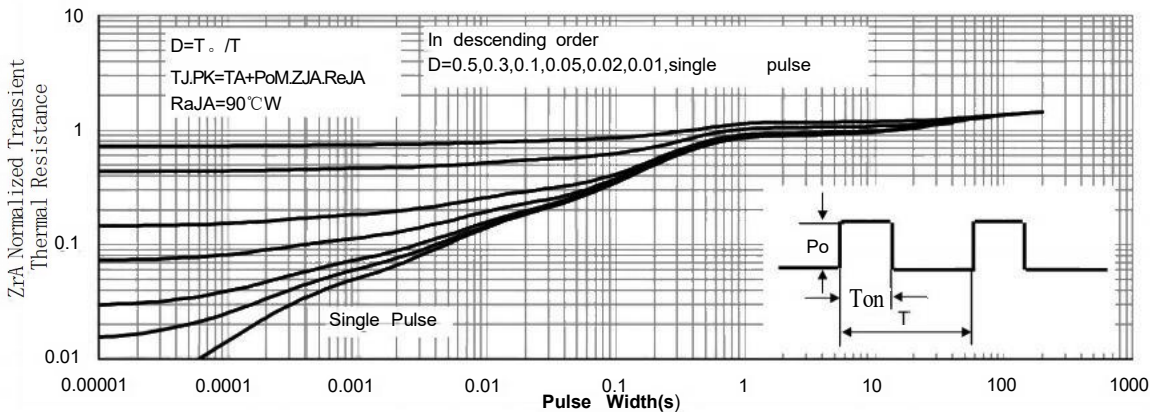
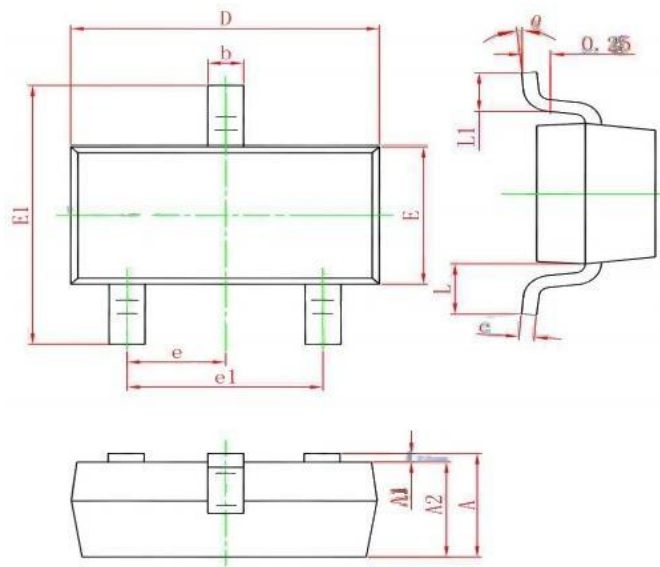


Figure 11:Normalized Maximum Transient Thermal Impedance

SOT 23 PACKAGE OUTLINE DIMENSIONS



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
C	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP.		0.037 TYP.	
e1	1.800	2.000	0.071	0.079
L	0.550 REF.		0.022 REF.	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°